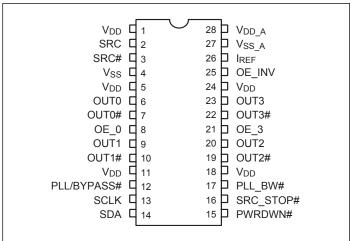




Pin Configuration



Pin Description

Pin#	Pin Name	Type	Description
2, 3	SRC & SRC#	Input	0.7V Differential SRC input from PI6C410 clock synthesizer
			3.3V LVTTL input for enabling outputs, active high.
8, 21	OE_0 & OE_3	Input	OE_0 for OUT0 / OUT0#
			OE_3 for OUT3 / OUT3#
0.5	OF DAY		3.3V LVTTL input for inverting the OE, SRC_STOP# and PWRDWN# pins.
25	OE_INV	Input	When 0 = same stage
			When 1 = OE_0, OE_3, SRC_STOP#, PWRDWN# inverted.
6, 7, 9, 10, 19, 20, 22, 23	OUT[0:3] & OUT[0:3]#	Output	0.7V Differential outputs
12	PLL/BYPASS#	Input	3.3V LVTTL input for selecting fan-out of PLL operation.
13	SCLK	Input	SMBus compatible SCLOCK input
14	SDA	I/O	SMBus compatible SDATA
26	IREF	Input	External resistor connection to set the differential output current
16	SRC_STOP#	Input	3.3V LVTTL input for SRC stop, active low
17	PLL_BW#	Input	3.3V LVTTL input for selecting the PLL bandwidth
15	PWRDWN#	Input	3.3V LVTTL input for Power Down operation, active low
1, 5, 11, 18, 24	V _{DD}	Power	3.3V Power Supply for Outputs
4	VSS	Ground	Ground for Outputs
27	VSS_A	Ground	Ground for PLL
28	VDD_A	Power	3.3V Power Supply for PLL





Serial Data Interface (SMBus)

This part is a slave only SMBus device that supports indexed block read and indexed block write protocol using a single 7-bit address and read/write bit as shown below.

Address Assignment

A6	A5	A4	A3	A2	A1	A0	W/R
1	1	0	1	1	1	0	0/1

Data Protocol

1 bit	7 bits	1	1	8 bits	1	8 bits	1	8 bits	1	8 bits	1	1 bit
Start bit	Slave Addr	R/W	Ack	Register offset	Ack	Byte Count = N	Ack	Data Byte 0	Ack	 Data Byte N - 1	Ack	Stop bit

Notes

Data Byte 0: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Source Pin
	Outputs Mode				
0	0 = Divide by 2	RW	1 = Normal	OUT[0:3], OUT[0:3]#	NA
	1 = Normal				
	PLL/BYPASS#				
1	0 = Fanout	RW	1 = PLL	OUT[0:3], OUT[0:3]#	NA
	1 = PLL				
	PLL Bandwidth				
2	0 = High Bandwidth,	RW	1 = Low	OUT[0:3], OUT[0:3]#	NA
	1 = Low Bandwidth				
3	Reserved				NA
4	Reserved				NA
5	Reserved				NA
	SRC_STOP#				
6	0 = Driven when stopped	RW	0 = Driven when stopped	OUT[0:3], OUT[0:3]#	NA
	1 = Tristate				
	PWRDWN#				
7	0 = Driven when stopped	RW	0 = Driven when stopped	OUT[0:3], OUT[0:3]#	NA
	1 = Tristate				

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^{1.} Register offset for indicating the starting register for indexed block write and indexed block read. Byte Count in write mode cannot be 0.





Data Byte 1: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Source Pin
0	Reserved				NA
1	OUTPUTS enable	RW	1 = Enabled	OUT0, OUT0#	NA
2	1 = Enabled 0 = Disabled	RW	1 = Enabled	OUT1, OUT1#	NA
3	Reserved				NA
4	Reserved				NA
5	OUTPUTS enable	RW	1 = Enabled	OUT2, OUT2#	NA
6	1 = Enabled 0 = Disabled	RW	1 = Enabled	OUT3, OUT3#	NA
7	Reserved				NA

Data Byte 2: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Source Pin
0	Reserved				NA
1	Allow control of OUTPUTS with	RW	0 = Free running	OUT0, OUT0#	NA
	assertion of SRC_STOP#				
2	0 = Free running	RW	0 = Free running	OUT1, OUT1#	NA
	1 = Stopped with SRC_Stop#				
3	Reserved				NA
4	Reserved				NA
5	Allow control of OUTPUTS with	RW	0 = Free running	OUT2, OUT2#	NA
	assertion of SRC_STOP#				
6	0 = Free running	RW	0 = Free running	OUT3, OUT3#	NA
	1 = Stopped with SRC_Stop#				
7	Reserved				NA





Data Byte 3: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Source Pin
0		RW			
1		RW			
2		RW			
3	D	RW			
4	Reserved	RW			
5		RW			
6		RW			
7		RW			

Data Byte 3: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0		R	0	NA	NA
1		R	0	NA	NA
2		R	0	NA	NA
3	Dominous ID	R	0	NA	NA
4	Pericom ID	R	0	NA	NA
5		R	1	NA	NA
6		R	0	NA	NA
7		R	0	NA	NA

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Functionality

PWRDWN#	OUT	OUT#	SRC_Stop#	OUT	OUT#
1	Normal	Normal	1	Normal	Normal
0	$I_{REF} \times 2$ or Float	Low	0	$I_{REF} \times 6$ or Float	Low

Power Down (PWRDWN# assertion)

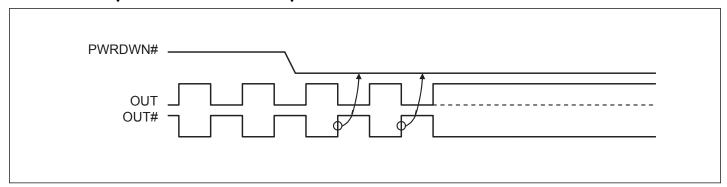


Figure 1. Power down sequence

Power Down (PWRDWN# De-assertion)

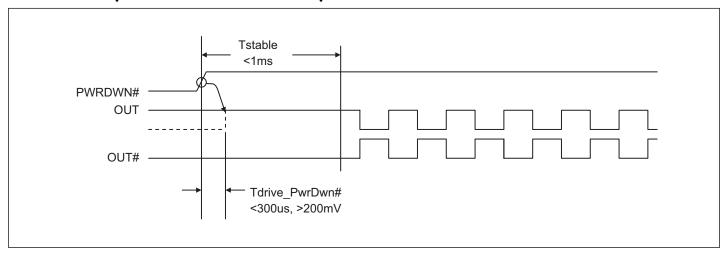
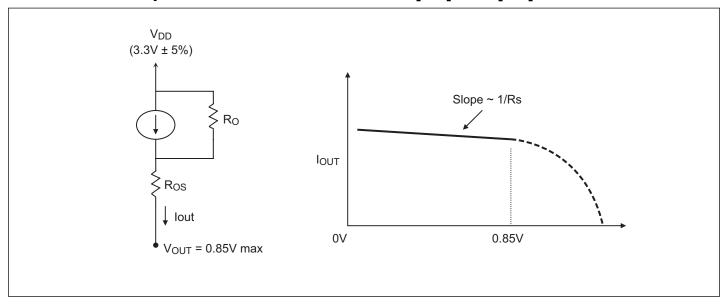


Figure 2. Power down de-assert sequence





Current-mode output buffer characteristics of OUT[0:3], OUT[0:3]#



Differential Clock Buffer characteristics

Symbol	Minimum	Maximum
R _o	3000Ω	N/A
R _{os}	unspecified	unspecified
Volum	N/A	850mV

Current Accuracy

Symbol	Conditions	Configuration	Load	Min.	Max.
I_{OUT}	$V_{\rm DD} = 3.30 \pm 5\%$	$R_{REF} = 475\Omega 1\%$ $I_{REF} = 2.32 \text{mA}$	Nominal test load for given configuration	-12% I _{nominal}	+12% I _{NOMINAL}

Note:

Differential Clock Output Current

Board Target Trace/Term Z	Reference R, Iref = $V_{DD}/(3xRr)$	Output Current	V _{он} @ Z
100Ω	$R_{REF} = 475\Omega \ 1\%,$	I 6 I	0.7V @ 50
(100Ω differential \approx 15% coupling ratio)	$I_{REF} = 2.32 \text{mA}$	$I_{OH} = 6 \times I_{REF}$	0.7 V @ 50

^{1.} $\rm I_{\tiny NOMINAL}$ refers to the expected current based on the configuration of the device.





Absolute Maximum Ratings (Over operating free-air temperature range)

Symbol	Parameters	Min.	Max.	Units
$V_{_{\mathrm{DD_A}}}$	3.3V Core Supply Voltage	-0.5	4.6	
V _{DD}	3.3V I/O Supply Voltage	-0.5	4.6	V
V _{IH}	Input High Voltage		4.6	V
V _{IL}	Input Low Voltage	-0.5		
Ts	Storage Temperature	-65	150	°C
V _{ESD}	ESD Protection	2000		V
T _J	Junction Temperature		125	°C

Note:

1. Stress beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.

DC Electrical Characteristics (V $_{\rm DD} = 3.3 \pm 5\%, \, \rm V_{\rm DD_A} = 3.3 \pm 5\%)$

Symbol	Parameters	Condition	Min.	Max.	Units	
$V_{_{\mathrm{DD_A}}}$	3.3V Core Supply Voltage		3.135	3.465		
V _{DD}	3.3V I/O Supply Voltage		3.135	3.465	V	
V _{IH}	3.3V Input High Voltage	$V_{ m DD}$	2.0	$V_{DD} + 0.3$		
V _{IL}	3.3V Input Low Voltage		V _{ss} - 0.3	0.8		
I _{IL}	Input Leakage Current	$0 < V_{IN} < V_{DD}$	-5	+5	μΑ	
V _{OH}	3.3V Output High Voltage	$I_{OH} = -1 \text{mA}$	2.4		V	
V _{OL}	3.3V Output Low Voltage	$I_{OL} = 1 \text{mA}$		0.4		
	0	$I_{OH} = 6 \times I_{REF}$	12.2			
	Output High Current	$I_{REF} = 2.32 \text{mA}$		15.6	mA	
C _{IN}	Input Pin Capacitance		3	5	Б	
C _{OUT}	Output Pin Capacitance			6	pF	
L _{PIN}	Pin Inductance			7	nН	
I _{DD(BYPASS)}	Power Supply Current (PLL Bypass)	$V_{DD} = 3.465V, F_{CPU} = 100MHz$		90		
$I_{_{ m DD}}$	Power Supply Current	$V_{\rm DD} = 3.465 V$	Bypass mode	100	mA	
<i>DD</i>		$F_{CPU} = 100MHz$	PLL mode	130		
I _{ss}	Power Down Current	Driven outputs		40		
I _{ss}	Power Down Current	Tristate outputs		12		
T _A	Ambient Temperature		-40	85	°C	

8





AC Switching Characteristics ($V_{DD} = 3.3 \pm 5\%$, $V_{DD_A} = 3.3 \pm 5\%$)

Symbol	Parameters	Condition	Min.	Тур.	Max.	Units
D.	PLL Mode		95		105	MHz
F_{IN}	Bypass Mode		100		400	MHz
T_{rise}/T_{fall}^{2}	Rise and Fall Time (measured between 0.175V to 0.525V)		175		700	ps
DT _{rise} /DT _{fall} ²	Rise and Fall Time Variation				125	ps
т	PLL Mode				±250	ps
T_{pd}	Non-PLL Mode		2.5		6.5	ns
T _{jitter} ^{3, 4}	Cycle – Cycle Jitter				50	ps
V_{HIGH}^{2}	Voltage High including overshoot		660		1150	mV
V_{LOW}^{2}	Voltage Low including undershoot		-300			mV
V_{cross}^{-2}	Absolute crossing point voltages		250		550	mV
DV _{cross} ²	Total Variation of Vcross over all edges				140	mV
T_{DC}^{-3}	Duty Cycle		45		55	%
t _{jphPCIeG1}		PCIe Gen1		30	86	ps (p-p)
	Phase Jitter, PLL Mode	PCIE_2_0_8MHz_1_5M_H3_ STEP, Low Freq.		0.7	3	ps (rms)
t _{jphPCIeG2}		PCIE_2_0_8MHz_1_5M_H3_ STEP, High Freq.		2	3.1	
L		PCIE_3_0_2MHz_5M_H3_ FIRST, Low Freq.		2	3	
t _{jphPCIeG3}		PCIE_3_0_2MHz_5M_H3_ FIRST, High Freq.		0.47	1	
$t_{jphPCIeG1}$		PCIe Gen1		0	0.001	ps (p-p)
t _{jphPCIeG2}	Additive Phase Jitter, Bypass Mode	PCIE_2_0_8MHz_1_5M_H3_ FIRST, Low Freq.		0	0.001	ps (rms)
		PCIE_2_0_8MHz_1_5M_H3_ FIRST, High Freq.		0	0.001	
t _{jphPCIeG3}		PCIE_3_0_2MHz_5M_H3_ FIRST, Low Freq.		0	0.001	
		PCIE_3_0_2MHz_5M_H3_ FIRST, High Freq.		0	0.001	

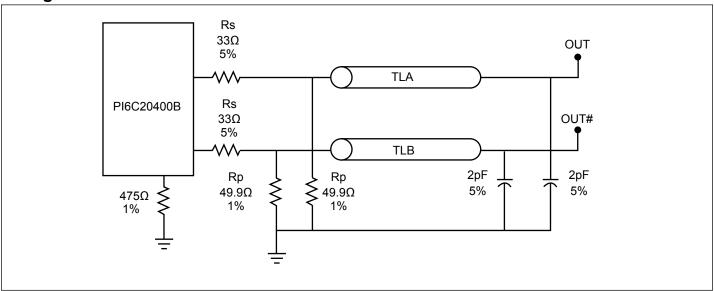
Notes:

- 1. Test configuration is $R_s = 33.2\Omega$, $Rp = 49.9\Omega$, and 2pF.
- 2. Measurement taken from Single Ended waveform.
- 3. Measurement taken from Differential waveform.
- 4. Measurement taken using M1 data capture analysis tool.
- 5. Additive jitter is calculated from input and output RMS phase jitter by using PCIe 2.0 filter. $(T_{jadd} = \sqrt{(output\ jitter)^2 (input\ jitter)^2}$





Configuration Test Load Board Termination



Part Marking

L Package



Y: Die Rev YY: Year

WW: Workweek

1st X: Assembly Code 2nd X: Fab Code

H Package



Y: Die Rev YY: Year

WW: Workweek

1st X: Assembly Code

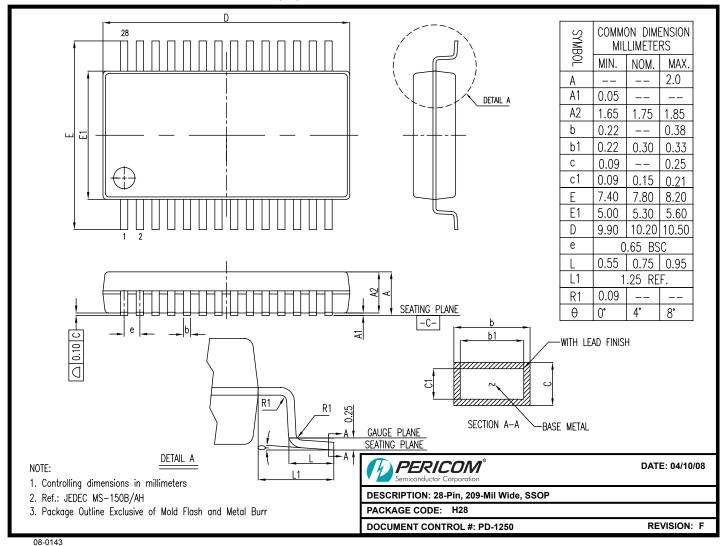
10

2nd X: Fab Code





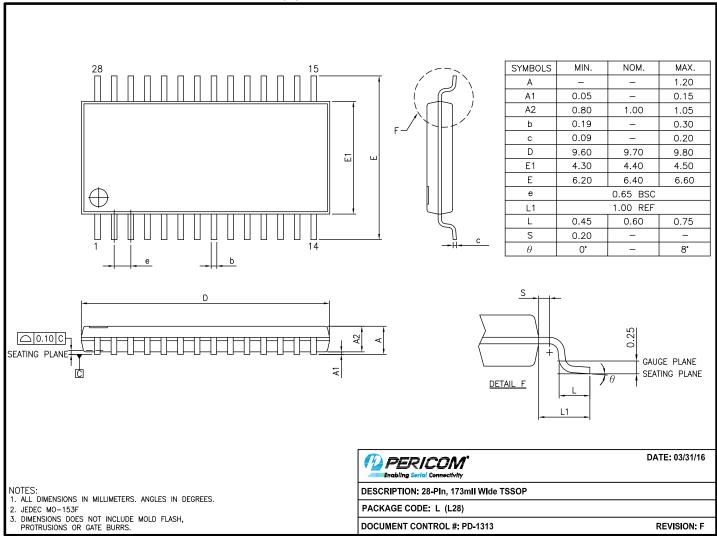
Packaging Mechanical: 28-SSOP (H)







Packaging Mechanical: 28-TSSOP (L)



16-0076

For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information

Ordering Code	Package Code	Package Description
PI6C20400BHEX	Н	28-pin, 209-mil wide (SSOP)
PI6C20400BLEX	L	28-pin, 173-mil wide (TSSOP)

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. E = Pb-free and Green
- 5. X suffix = Tape/Reel





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